

2SP0320T2Cx-17 Preliminary Data Sheet

Compact, high-performance, plug-and-play dual-channel IGBT driver based on SCALE[™]-2 technology for individual and parallel-connected modules in 2-level, 3-level and multilevel converter topologies

Abstract

The SCALE[™]-2 plug-and-play driver 2SP0320T2Cx-17 is a compact dual-channel intelligent gate driver designed for 1700V IGBT modules from Danfoss, Fuji or Infineon. The driver features an electrical interface with a built-in DC/DC power supply.

The turn-on and turn-off gate resistors of both channels are not assembled in order to provide maximum flexibility. They must be assembled by the user before start of operation. Please refer to the paragraph on "Gate Resistor Assembly" for the recommended gate resistors.

For drivers adapted to other types of high-power and high-voltage IGBT modules, refer to

www.IGBT-Driver.com/go/plug-and-play

| Features | Applications |
|--|---|
| Plug-and-play solution Allows parallel connection of IGBT modules For 2-level, 3-level and multilevel topologies Shortens application development time Extremely reliable; long service life Built-in DC/DC power supply 20-pin flat cable interface Duty cycle 0 100% Active clamping of V_{ce} at turn-off IGBT short-circuit protection Monitoring of supply voltage Safe isolation to EN 50178 UL compliant Suitable for 1700V IGBT modules | Wind-power converters Industrial drives UPS Power-factor correctors Traction Railroad power supplies Welding SMPS Radiology and laser technology Research and many others |
| ✓ Gate resistors not assembled | |

Safety Notice!

The data contained in this data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 60747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

Important Product Documentation

This data sheet contains only product-specific data. For a detailed description, must-read application notes and common data that apply to the whole series, please refer to "Description & Application Manual for 2SP0320T SCALE-2 IGBT Drivers" on <u>www.IGBT-Driver.com/go/2SP0320</u>.

The gate resistors on this gate driver are not assembled in order to provide maximum flexibility. For the gate resistors required for specific IGBT modules, refer to the paragraph on "Gate Resistor Assembly". Use of gate resistors other than those specified may result in failure.

Mechanical Dimensions

Dimensions: See the relevant "Description and Application Manual"

Mounting principle: Connected to IGBT module with screws

Absolute Maximum Ratings

| Parameter | Remarks | Min | Max | Unit |
|------------------------------------|---|------|--------|----------------------|
| Supply voltage V _{DC} | VDC to GND | 0 | 16 | V |
| Supply voltage V _{cc} | VCC to GND (Note 1) | 0 | 16 | V |
| Logic input and output voltages | To GND | -0.5 | VCC+0. | 5 V |
| SO _x current | Fault condition, total current | | 20 | mA |
| Gate peak current I _{out} | Note 2 | -20 | +20 | А |
| Average supply current I_{DC} | Note 16 | | 600 | mA |
| Output power per gate | Ambient temperature <70°C (Note 3) | | 3 | W |
| | Ambient temperature 85°C (Note 3) | | 2 | W |
| Turn-on gate resistance | Note 17 | 0.3 | | Ω |
| Turn-off gate resistance | Note 17 | 1 | | Ω |
| Switching frequency F | Note 23 | | n.d. | kHz |
| Test voltage (50Hz/1min.) | Primary to secondary (Note 19) | | 5000 | V _{AC(eff)} |
| | Secondary to secondary (Note 19) | | 4000 | V _{AC(eff)} |
| DC-link voltage | Note 4 | | 1200 | V |
| dV/dt | Rate of change of input to output voltage (Note 20) | | 50 | kV/µs |
| Operating voltage | Primary/secondary, secondary/secondary | | 1700 | V_{peak} |

| Parameter | Remarks | Min | Мах | Unit |
|-----------------------|---------|------------|------------|----------|
| Operating temperature | | -40 -40 | +85 +90 | °C °C |
| Storage temperature | | -40 | +90 | C |

Recommended Operating Conditions

| Power Supply | Remarks | Min | Тур | Мах | Unit |
|--------------------------------|-----------------------------|------|-----|----------|------|
| Supply voltage V _{DC} | To GND (Note 1) | 14.5 | 15 | 15.5 | V |
| Supply voltage V_{CC} | To GND (Note 1) | 14.5 | 15 | 15.5 | V |
| Resistance from TB to GND | Blocking time≠0, ext. value | 128 | | ∞ | kΩ |

Electrical Characteristics

| Power Supply | Remarks | Min | Тур | Мах | Unit |
|--|--|--------|------|------|------|
| Supply current I _{DC} | Without load | | 37 | | mA |
| Efficiency η | Internal DC/DC converter | | 85 | | % |
| Supply current I _{CC} | Without load | | 19 | | mA |
| Coupling capacitance C _{io} | Primary side to secondary side, total, per c | hannel | 20 | | pF |
| Power Supply Monitoring | Remarks | Min | Тур | Мах | Unit |
| Supply threshold V _{cc} | Primary side, clear fault | 11.9 | 12.6 | 13.3 | V |
| | Primary side, set fault (Note 5) | 11.3 | 12.0 | 12.7 | V |
| Monitoring hysteresis | Primary side, set/clear fault | 0.35 | | | V |
| Supply threshold V _{isox} -V _{eex} | Secondary side, clear fault | 12.1 | 12.6 | 13.1 | V |
| | Secondary side, set fault (Note 21) | 11.5 | 12.0 | 12.5 | V |
| Monitoring hysteresis | Secondary side, set/clear fault | 0.35 | | | V |
| Supply threshold V_{eex} - V_{COMx} | Secondary side, clear fault | 5 | 5.15 | 5.3 | V |
| | Secondary side, set fault (Note 21) | 4.7 | 4.85 | 5 | V |
| Monitoring hysteresis | Secondary side, set/clear fault | 0.15 | | | V |
| Logic Inputs and Outputs | Remarks | Min | Тур | Мах | Unit |
| Input impedance | V(INx) = 15V (Note 6) | 4.3 | 4.5 | 4.6 | kΩ |
| Turn-on threshold | V(INx) (Note 7) | | 10.5 | | V |
| Turn-off threshold | V(INx) (Note 7) | | 5 | | V |
| SOx pull-up resistor to VCC | On board | | 10 | | kΩ |
| SOx output voltage | Fault condition, I(SOx)<6.5mA | | | 0.7 | V |

| Short-circuit Protection | Remarks | Min | Тур | Мах | Unit |
|---|---|---------------|--------|--------|-------------------|
| Vce-monitoring threshold | Between auxiliary terminals | | 10.2 | | V |
| Response time | DC-link voltage > 550V (Note 8) | | 6.9 | | μs |
| Delay to IGBT turn-off | After the response time (Note 9)1.4 | | | μs | |
| Blocking time | After fault (Note 10) | 90 | | | ms |
| Timing Characteristics | Remarks | Min | Тур | Мах | Unit |
| Turn-on delay t _{d(on)} | Note 11 | | 95 | | ns |
| Turn-off delay t _{d(off)} | Note 11 | | 75 | | ns |
| Jitter of turn-on delay | Note 12 | | ±2 | | ns |
| Jitter of turn-off delay | Note 12 | | ±2 | | ns |
| Output rise time tr(out) | G_x to E_x (Note 13) | | 7 | | ns |
| Output fall time $t_{f(out)}$ | G_x to E_x (Note 13) | | 25 | | ns |
| Dead time between outputs | Half-bridge mode (Note 14) | | 3 | | μs |
| Jitter of dead time | Half-bridge mode | | ±100 | | ns |
| Transmission delay of fault state | Note 15 | | 450 | | ns |
| Outputs | Remarks | Min | Тур | Мах | Unit |
| Turn-on gate resistor R _{g(on)} | Note 17 | not | assemb | oled | Ω |
| Turn-off gate resistor R _{g(off)} | Note 17 | not assembled | | Ω | |
| Gate voltage at turn-on | | | 15 | | V |
| Gate-voltage at turn-off | P = OW | | -10.4 | | V |
| | P = 0.3W | | -10.2 | | V |
| | P = 2.1W | | -9.7 | | V |
| | P = 3W | | -9.6 | | V |
| Gate resistance to COMx | | | 4.7 | | kΩ |
| dV/dt Feedback | Remarks | Im | plemen | tation | |
| dV/dt feedback | Note 18 | | No | | |
| Electrical Isolation | Remarks | Min | Тур | Мах | Unit |
| Test voltage (50Hz/1s) | Primary to secondary side (Note 19) | 5000 | 5050 | 5100 | V_{eff} |
| | Secondary to secondary side (Note 19) | 4000 | 4050 | 4100 | V_{eff} |
| Partial discharge extinction volt. | Primary to secondary side (Note 22) | 1768 | | | V_{peak} |
| - | Secondary to secondary side (Note 22) | 1700 | | | V _{peak} |
| Creepage distancePrimary to secondary side20Secondary to secondary side17 | | 20 | | | mm |
| | | | mm | | |
| All data refer to $\pm 25^{\circ}$ C and V _{oo} = | $V_{DC} = 15V$ unless otherwise specified | | | | |

All data refer to +25°C and V_{CC} = V_{DC} = 15V unless otherwise specified

Footnotes to the Key Data

- 1) Both supply voltages V_{DC} and V_{CC} should be applied in parallel.
- 2) The gate current is limited by the gate resistors located on the driver.
- 3) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload. From 70°C to 85°C, the maximum permissible output power can be linearly interpolated from the given data.
- 4) This limit is due to active clamping. Refer to "Description & Application Manual for 2SP0320T SCALE-2 IGBT Drivers".
- 5) Undervoltage monitoring of the primary-side supply voltage (VCC to GND). If the voltage drops below this limit, a fault is transmitted to the corresponding output(s) and the IGBTs are switched off.
- 6) The input impedance can be modified (customer-specific solution).
- 7) Turn-on and turn-off threshold values can be modified (customer-specific solution).
- 8) The resulting pulse width of the direct output of the gate drive unit for short-circuit type I (excluding the delay of the gate resistors) is the sum of response time plus delay to IGBT turn-off.
- 9) The turn-off event of the IGBT is delayed by the specified time after the response time.
- 10) Factory set value. The blocking time can be reduced with an external resistor. Refer to "Description & Application Manual for 2SP0320T SCALE-2 IGBT Drivers".
- 11) Measured from the transition of the turn-on or turn-off command at the driver input to direct output of the gate drive unit (excluding the delay of the gate resistors).
- 12) Jitter measurements are performed with input signals INx switching between 0V and 15V referred to GND, with a corresponding rise time and fall time of 8ns.
- 13) Refers to the direct output of the gate drive unit (excluding the delay of the gate resistors).
- 14) Note that the dead time may vary from sample to sample. A tolerance of approximately ±20% may be expected. If higher timing precisions are required, CONCEPT recommends using direct mode and generating the dead time externally.
- 15) Transmission delay of the fault state from the secondary side to the primary status outputs.
- 16) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload.
- 17) The gate resistors are not assembled on this IGBT gate driver. They must be assembled by the user according to the paragraph on "Gate Resistor Assembly".
- 18) A dV/dt feedback can optionally be implemented in order to reduce the rate of rise of the collector emitter voltage of the IGBTs at turn-off (customer-specific solution).
- 19) HiPot testing (= dielectric testing) must generally be restricted to suitable components. This gate driver is suited for HiPot testing. Nevertheless, it is strongly recommended to limit the testing time to 1s slots as stipulated by EN 50178. Excessive HiPot testing at voltages much higher than 1200V_{AC(eff)} may lead to insulation degradation. No degradation has been observed over 1min. testing at 5000V_{AC(eff)}. Every production sample shipped to customers has undergone 100% testing at the given value for 1s.
- 20) This specification guarantees that the drive information will be transferred reliably even at a high DClink voltage and with ultra-fast switching operations.
- 21) Undervoltage monitoring of the secondary-side supply voltage (Visox to Veex and Veex to COMx which correspond with the approximate turn-on and turn-off gate-emitter voltages). If the corresponding voltage drops below this limit, the IGBT is switched off and a fault is transmitted to the corresponding output.
- 22) Partial discharge measurement is performed in accordance with IEC 60270 and isolation coordination specified in EN 50178. The partial discharge extinction voltage between primary and either secondary side is coordinated for safe isolation to EN 50178.
- 23) The maximum switching frequency is not defined, as it depends on the IGBT module used. Please consult the corresponding driver data sheet for more information.

Gate Resistor Assembly

The turn-on and turn-off gate resistors of 2SP0320T2Cx drivers are adapted to their respective IGBT modules. Recommended gate resistors are: PR02 / 2W / 5% from Vishay.

| 1700V IGBT Type | R120/R121/ R220/R221 | R122/R123 / R222/R223 | Resulting Rg,on | Resulting Rg,off |
|---------------------|-------------------------|--------------------------|--------------------|---------------------|
| FF450R17IE4 | 5.6Ω | 10Ω | 2.8Ω | 5Ω |
| 2MBI650VXA-170E-50 | 3.6Ω | 6.8Ω | 1.8Ω | 3.4Ω |
| FF650R17IE4 | 3.6Ω | 6.8Ω | 1.8Ω | 3.4Ω |
| FF650R17IE4D_B2 | 2Ω | 6.8Ω | 1Ω | 3.4Ω |
| 2MBI1000VXB-170E-50 | 3.6Ω | 5.1Ω | 1.8Ω | 2.55Ω |
| DP1000B1700T103715 | 2.2Ω | 5.6Ω | 1.1Ω | 2.8Ω |
| FF1000R17IE4 | 2.4Ω | 6.8Ω | 1.2Ω | 3.4Ω |
| FF1000R17IE4D_B2 | 0.68Ω | 4.7Ω | 0.34Ω | 2.35Ω |
| 2MBI1400VXB-170E-50 | 1Ω | 1.8Ω | 0.5Ω | 0.9Ω |
| 2MBI1400VXB-170P-50 | 1Ω | 2Ω | 0.5Ω | 1.0Ω |
| FF1400R17IP4 | 1Ω | 3.3Ω | 0.5Ω | 1.65Ω |

The following versions exist:

For the component position, refer to Fig. 1.

Assembly Drawing

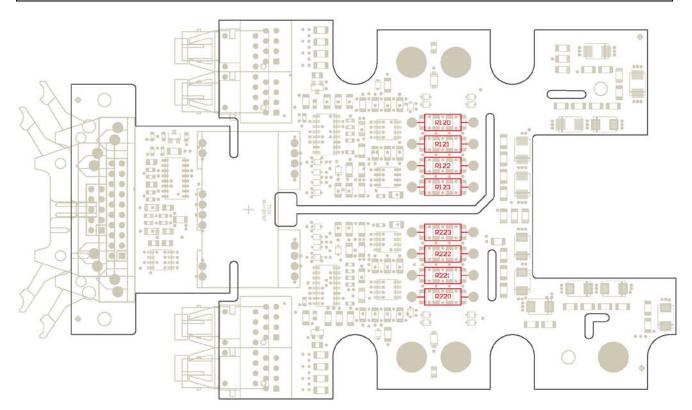


Fig. 1: Assembly drawing of 2SP0320 with highlighted gate resistors

Note that the wires of the gate resistors should not project more than 1.6mm after soldering (excess length at bottom side). Furthermore, a minimum distance of 1mm must be maintained between the gate resistor body and the PCB.

Legal Disclaimer

This data sheet specifies devices but cannot promise to deliver any specific characteristics. No warranty or guarantee is given – either expressly or implicitly – regarding delivery, performance or suitability.

CT-Concept Technologie GmbH reserves the right to make modifications to its technical data and product specifications at any time without prior notice. The general terms and conditions of delivery of CT-Concept Technologie GmbH apply.

Related IGBT

1700V IGBT modules

Preliminary Data Sheet

Ordering Information

The general terms and conditions of delivery of CT-Concept Technologie GmbH apply.

CONCEPT Driver Type

2SP0320T2C0-17 (Only 15V logic supported)

Product home page: <u>www.IGBT-Driver.com/go/2SP0320</u>

Refer to <u>www.IGBT-Driver.com/go/nomenclature</u> for information on driver nomenclature

Information about Other Products

For other drivers, evaluation systems product documentation and application support

Please click: <u>www.IGBT-Driver.com</u>

Manufacturer

CT-Concept Technologie GmbH A Power Integrations Company Johann-Renfer-Strasse 15 2504 Biel-Bienne Switzerland

Phone +41 - 32 - 344 47 47 Fax +41 - 32 - 344 47 40

E-mail <u>Info@IGBT-Driver.com</u> Internet <u>www.IGBT-Driver.com</u>

© 2008...2014 CT-Concept Technologie GmbH - Switzerland. All rights reserved. We reserve the right to make any technical modifications without prior notice. Version 2.0 from 2016-05-20